

FPF3040

IntelliMAX™ 20 V-Rated Dual Input Single Output Power-Source-Selector Switch

Features

- Dual-Input, Single-Output Load Switch
- Input Supply Operating Range:
 - 4~10.5 V at V_{IN}
 - 4~6.5 V at V_{BUS}
- Typical R_{ON} :
 - 95 mΩ at $V_{IN}=5$ V
 - 70 mΩ at $V_{BUS}=5$ V
- Bi-Directional Switch for V_{IN} and V_{BUS}
- Slew Rate Controlled:
 - 50 μs at V_{IN} for < 4.7 μF C_{OUT}
 - 90 μs at V_{BUS} for < 4.7 μF C_{OUT}
- Maximum I_{SW} : 2 A Per Channel
- Break-Before-Make Transition
- Under-Voltage Lockout (UVLO)
- Over-Voltage Lockout (OVLO)
- Thermal Shutdown
- Logic CMOS IO Meets JESD76 Standard for GPIO Interface and Related Power Supply Requirements
- ESD Protected:
 - Human Body Model: >3 kV
 - Charged Device Model: >1.5 kV
 - IEC 61000-4-2 Air Discharge: >15 kV
 - IEC61000-4-2 Contact Discharge: >8 kV

Applications

- Input Power Selection Block Supporting USB and Wireless Charging
- Smartphone / Tablet PC

Description

The FPF3040 is a 20 V-rated Dual-Input Single-Output (DISO) load switch consisting of two channels of slew-rate-controlled, low-on-resistance, N-channel MOSFET switches with protection features. The slew-rate-controlled turn-on characteristic prevents inrush current and the resulting excessive voltage droop on the input power rails. The input voltage range operates from 4 V to 6.5 V at V_{BUS} and from 4 V to 10.5 V at V_{IN} to align with the needs of low-voltage portable device power rails.

V_{IN} and V_{BUS} have the over-voltage protection functionality of typical 12 V and 7.5 V, respectively, to avoid unwanted damage to system.

V_{IN} and V_{BUS} bi-directional switching allows reverse current from V_{OUT} to V_{IN} or V_{BUS} for On-The-Go, (OTG) Mode. The switching is controlled by logic input EN and V_{IN_SEL} is capable of interfacing directly with low-voltage control signal General-Purpose Input / Output (GPIO).

FPF3040 is available in 1.8 mm x 2.0 mm Wafer-Level Chip-Scale Package (WLCSP), 16-bump, 0.4 mm pitch.

Ordering Information

Part Number	Top Mark	Channel	Typical R_{ON} per Channel at 5V _{IN}	Rise Time (t _R)	Package
FPF3040UCX	QY	DISO	95 mΩ for V_{IN}	50 μs for V_{IN}	1.8 mm x 2.0 mm Wafer-Level Chip-Scale Package (WLCSP), 16-Bump, 0.4 mm Pitch
			70 mΩ for V_{BUS}	90 μs for V_{BUS}	

Application Diagram

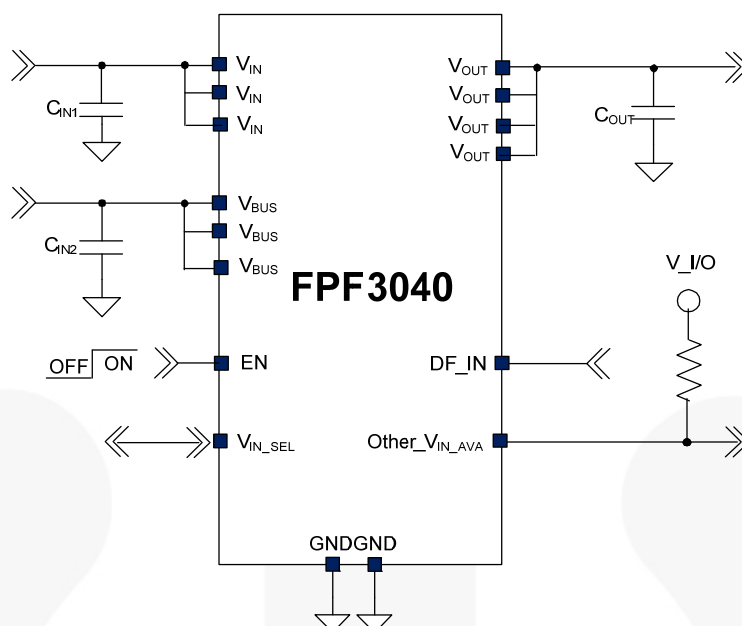


Figure 1. Typical Application

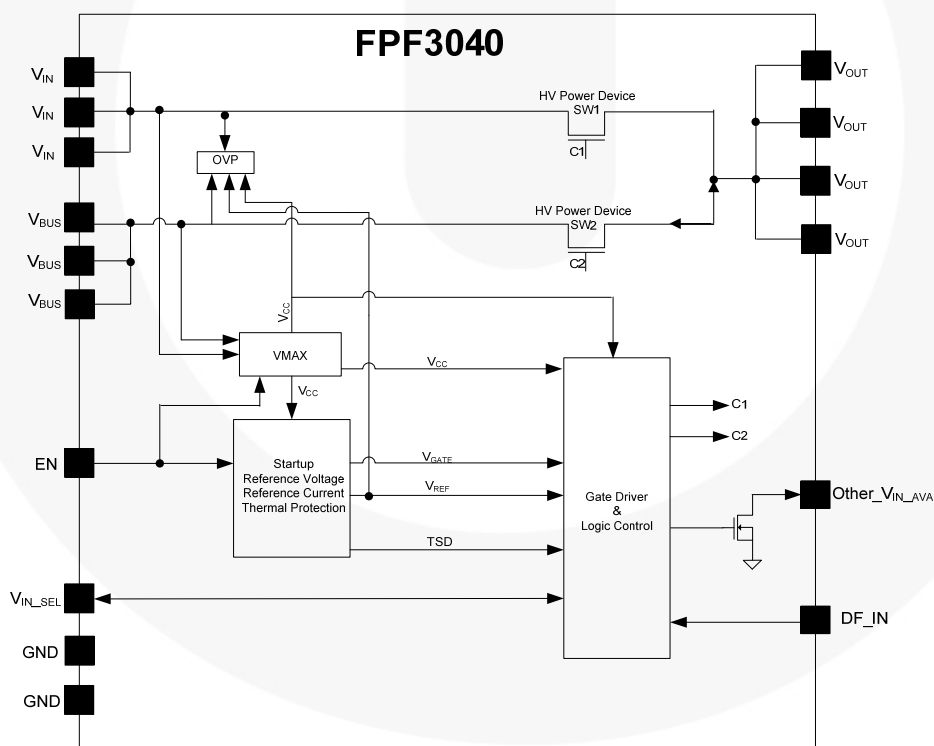
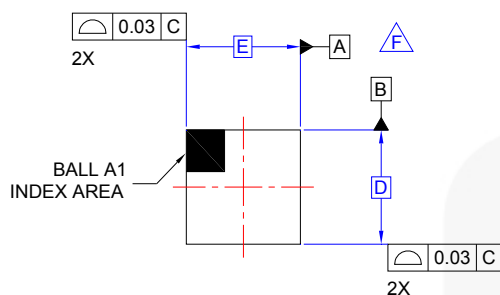
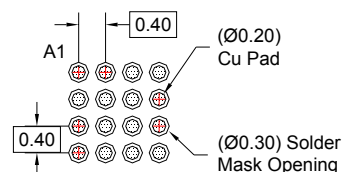


Figure 2. Functional Block Diagram

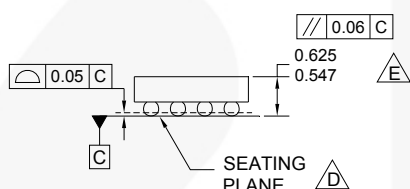
Package Description



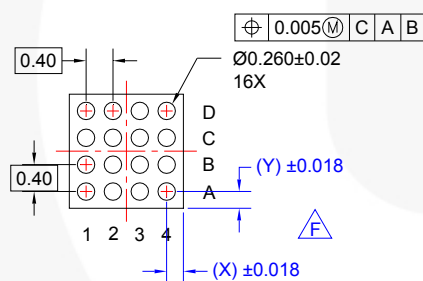
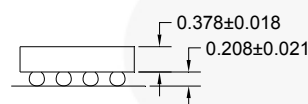
TOP VIEW



RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)



SIDE VIEWS



BOTTOM VIEW

NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASME Y14.5M, 1994.
- D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 586 MICRONS ± 39 MICRONS (547-625 MICRONS).
- F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC016AArev2.

Figure 31.1.8 mm x 2.0 mm Wafer-Level Chip-Scale Package (WLCSP), 16-Bump, 0.4 mm Pitch

Product	D	E	X	Y
FPF3040UCX	1.96 mm ± 0.03 mm	1.76 mm ± 0.03 mm	0.28 mm	0.38 mm

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ESBC™	MicroPak™	STEALTH™	
 Fairchild®	MicroPak2™	SuperFET®	UHC®
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FACT Quiet Series™	MotionMax™	SuperSOT™-6	UniFET™
FACT®	mWSaver™	SuperSOT™-8	VCM™
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